

AN 82:128418 HCA
 TI **Copper**-thallium alloys with good heat resistance and electrical conductivity
 IN Sakamoto, Mutsuo; Sotomura, Takashi
 PA Furukawa Electric Co., Ltd.
 SO Japan., 3 pp.
 CODEN: JAXXAD
 DT Patent
 LA Japanese
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| | PATENT NO. | KIND | DATE | APPLICATION NO. | DATE |
|----|--|------|----------|-----------------|----------|
| PI | JP 49007777 | B4 | 19740222 | JP 1970-87320 | 19701005 |
| AB | The Cu alloy contains Tl 0.005-0.08 and O >0.0005%. The alloy is cooled from 900-1050.degree. at >5 .degree.C/min, hot worked at >750.degree., cold worked, and annealed at >600.degree.. | | | | |

(3, 14, 19)